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(54) Title: DUAL-DAMASCENE INTERCONNECTS WITHOUT AN ETCH STOP LAYER BY ALTERNATING ILDS

(57) Abstract: A dual damascene process where first alternate ILDs are made of a first material and second alternate ILDs are made of a second material. Each material is etchable at a faster rate than the other in the presence of different etchant such as for an organic polymer and an inorganic low K material. This allows the ILDs to be deposited alternately on one another without an etchant stop layer thereby reducing capacitance.